

## 2.2.2 Antenna efficiency and gain

Left ear antenna efficiency and gain			
frequency point (MHz)	workpiece ratio (%)	workpiece ratio (dB)	Gain (dBi)
2400	24%	-6.38	-2.21
2410	25%	-6.38	-1.95
2420	26%	-6.38	-1.80
2430	28%	-6.38	-1.71
2440	27%	-6.38	-1.50
2450	29%	-6.38	-1.33
2460	28%	-6.38	-1.40
2470	27%	-6.38	-1.65
2480	25%	-6.38	-1.71
2490	25%	-6.38	-1.86
2500	23%	-6.38	-2.01

Right ear antenna efficiency and gain			
frequency point (MHz)	workpiece ratio (%)	workpiece ratio (dB)	Gain (dBi)
2400	23%	-6.38	-2.01
2410	24%	-6.20	-2.21
2420	25%	-6.02	-1.88
2430	27%	-5.69	-1.74
2440	29%	-5.38	-1.46
2450	28%	-5.53	-1.39
2460	28%	-5.53	-1.37
2470	27%	-5.69	-1.46
2480	25%	-6.02	-1.59
2490	24%	-6.20	-1.98
2500	23%	-6.38	-2.21

## 2.2.3 Antenna OTA

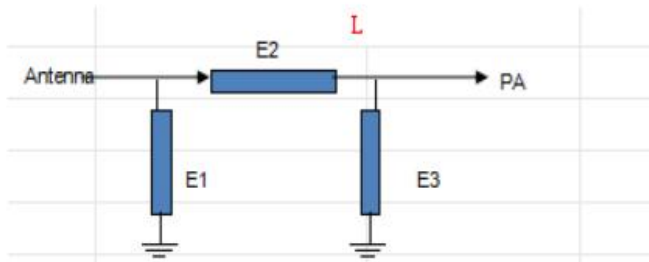
free space	Channel	TRP (dBm)	TIS (dBm)
L	0	4.95	-88.45
	39	5.32	-88.32
	78	5.15	-89.01

free space	Channel	TRP (dBm)	TIS (dBm)
R	0	5.12	-88.65
	39	4.89	-89.01
	78	4.87	-89.32

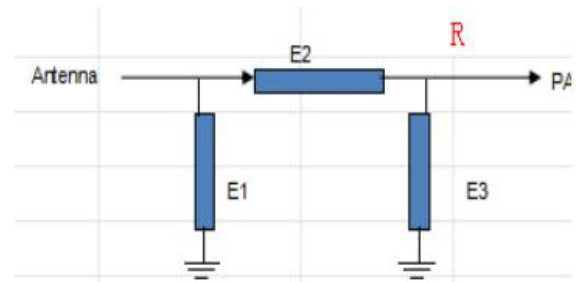
ear	Channel	TRP (dBm)	TIS (dBm)
L	0	-1.78	-82.14
	39	-1.85	-82.50
	78	-2.01	-82.35

ear	Channel	TRP (dBm)	TIS (dBm)
R	0	-1.87	-82.25
	39	-1.94	-82.52
	78	-2.14	-82.60

### 2.2.4 The left and right ears match the same, as shown below



Element	Value
E1(0201)	9.1NH
E2(0201)	0欧姆
E3(0201)	N/A



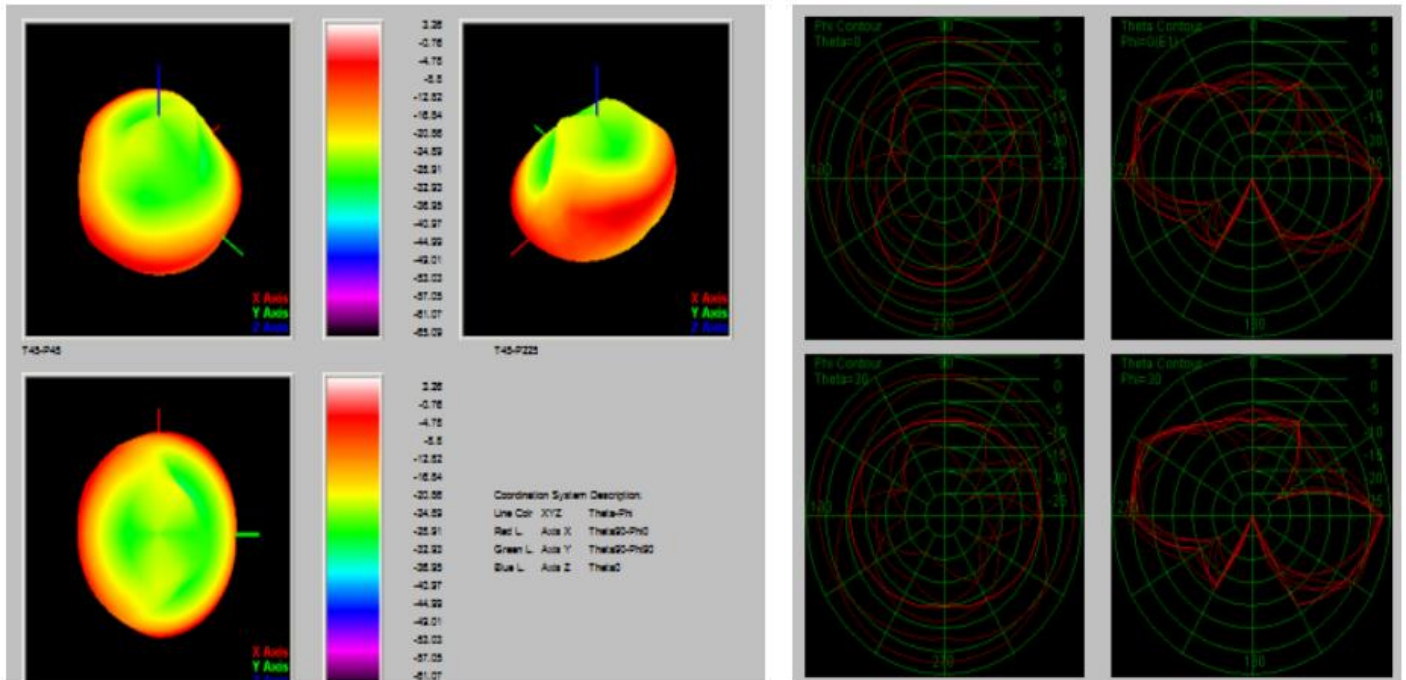
Element	Value
E1(0201)	9.1NH
E2(0201)	0欧姆
E3(0201)	N/A

### 2.2.5 Headset assembly precautions

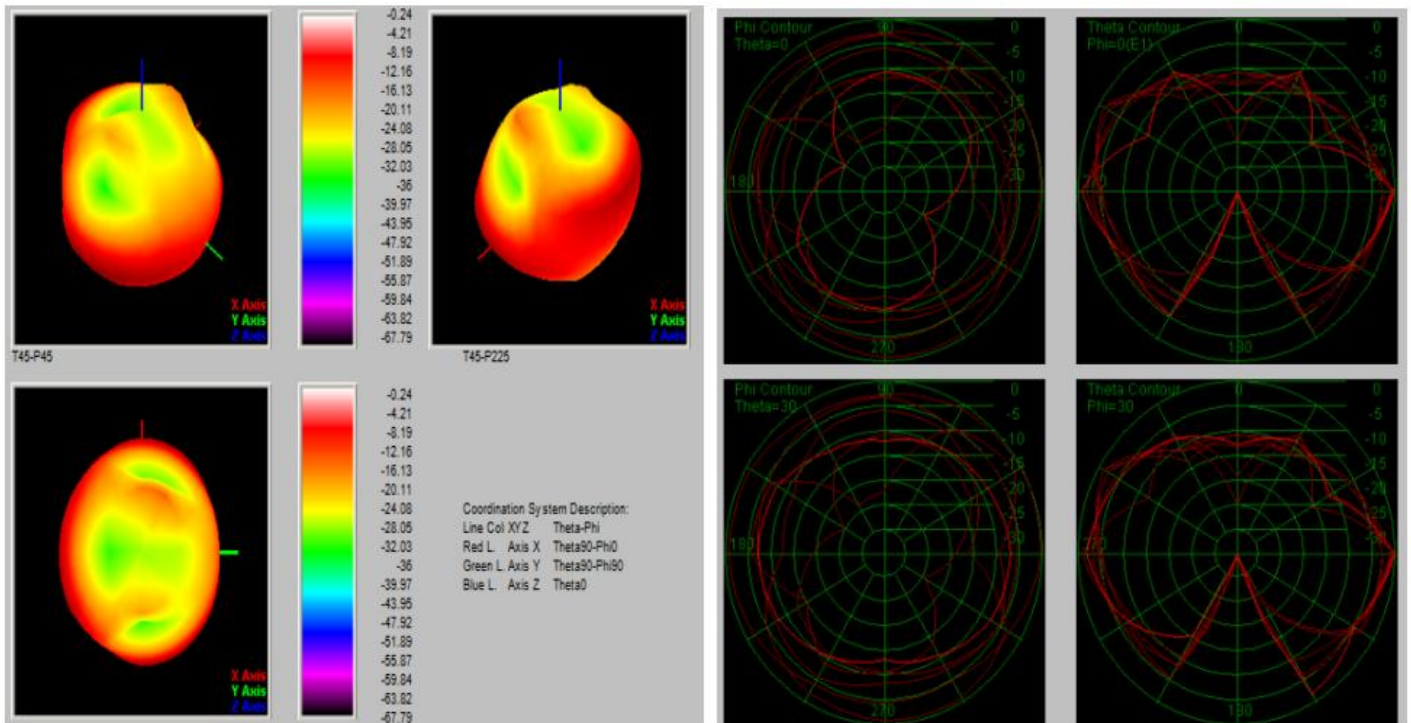


Speaker cable Battery cable twisted 3 turns, as shown in the figure (refer to project 2161B)

### 2.2.6 Direction diagram -L



### 2.2.7 Direction diagram -R



### 3. Structural drawings

#### L antenna

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<p>skills requirement:</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td>1. FPC substrate specifications:</td> <td>PI substrate:</td> <td>Electrolytic copper (half to half)</td> </tr> <tr> <td>2. Electroplating specifications:</td> <td>Electrolytic copper: 0.5oz (oz)</td> <td></td> </tr> <tr> <td>3. Surface ink requirements:</td> <td>Double-sided tape:</td> <td>TESA 68532</td> </tr> <tr> <td></td> <td>Nickel plated: 3*9mm</td> <td></td> </tr> <tr> <td></td> <td>Surface ink color:</td> <td>Gilded: 0.025um</td> </tr> <tr> <td></td> <td>Printing font color:</td> <td>Matte black</td> </tr> <tr> <td></td> <td>Printing font height:</td> <td>WHITE</td> </tr> <tr> <td></td> <td></td> <td>According to drawings</td> </tr> </table> <p>4. Reliability requirements:</p> <ol style="list-style-type: none"> <li>1. Reliability test: salt spray test\rubber friction test\alcohol resistance test\100 grid test.</li> <li>2. The front ink, the surface of the ink is required to be folded in half without cracking, scratching, etc.</li> </ol> <p>5. Tolerance requirements:</p> <ol style="list-style-type: none"> <li>1. Shape tolerance <math>\pm 0.10</math>;</li> <li>2. Copper foil circuit tolerance <math>\pm 0.05</math>;</li> <li>3. The position of the copper foil to the shape is <math>\pm 0.15</math>;</li> <li>4. Hole-to-hole position tolerance <math>\pm 0.10</math>; hole-to-shape position tolerance <math>\pm 0.15</math>;</li> <li>5. The size tolerance of gold finger is <math>\pm 0.20</math>.</li> <li>6. For other unmarked dimensions, refer to 2D drawings.</li> </ol> <p>6. Key control size: The dimensions marked with numbers are regarded as important dimensions, and the others refer to 2D drawings</p> <p>7. Environmental requirements: Parts meet ROHS2.0/RE/Reach/6P environmental protection requirements</p> <p>8. Packaging requirements:</p>				1. FPC substrate specifications:	PI substrate:	Electrolytic copper (half to half)	2. Electroplating specifications:	Electrolytic copper: 0.5oz (oz)		3. Surface ink requirements:	Double-sided tape:	TESA 68532		Nickel plated: 3*9mm			Surface ink color:	Gilded: 0.025um		Printing font color:	Matte black		Printing font height:	WHITE			According to drawings				
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R antenna

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